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BUK7K52-60E

Dual N-channel 60 V, 45 m Ω standard level MOSFET

10 December 2013

Product data sheet

1. General description

Dual standard level N-channel MOSFET in an LFPAK56D (Dual Power-SO8) package using TrenchMOS technology. This product has been designed and qualified to AEC Q101 standard for use in high performance automotive applications.

2. Features and benefits

- Dual MOSFET
- Q101 compliant
- Repetitive avalanche rated
- Suitable for thermally demanding environments due to 175 °C rating
- True standard level gate with V_{GS(th)} of greater than 1 V at 175 °C

3. Applications

- 12 V Automotive systems
- Motors, lamps and solenoid control
- Transmission control
- Ultra high performance power switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	60	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; <u>Fig. 1</u>		-	-	15.4	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 2</u>		-	-	32	W
Static characte	Static characteristics FET1 and FET2						
R _{DSon}	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 5 \text{ A}; T_j = 25 \text{ °C}; Fig. 11$		-	35	45	mΩ
Dynamic characteristics FET1 and FET2							
Q_{GD}	gate-drain charge	$I_D = 5 \text{ A}; V_{DS} = 48 \text{ V}; V_{GS} = 10 \text{ V};$ $T_j = 25 \text{ °C}; Fig. 13; Fig. 14$		-	3.5	-	nC



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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S1	source1	8 7 6 5	D1 D1 D2 D2
2	G1	gate1	1	
3	S2	source2		
4	G2	gate2		
5	D2	drain2		
6	D2	drain2	_	mbk725
7	D1	drain1	1 2 3 4 LFPAK56D (SOT1205)	
8	D1	drain1	21.7.1.1005 (0011200)	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
BUK7K52-60E	LFPAK56D	Plastic single ended surface mounted package (LFPAK56D); 8 leads	SOT1205			

7. Marking

Table 4. Marking codes

Type number	Marking code
BUK7K52-60E	75260E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	60	V
V_{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	60	V
V _{GS}	gate-source voltage	T _j ≤ 175 °C; DC	-20	20	V
I _D	drain current	T _{mb} = 25 °C; V _{GS} = 10 V; <u>Fig. 1</u>	-	15.4	Α
		T _{mb} = 100 °C; V _{GS} = 10 V; <u>Fig. 1</u>	-	12.6	Α
I _{DM}	peak drain current	T_{mb} = 25 °C; pulsed; $t_p \le 10 \mu s$; Fig. 4	-	71	Α
P _{tot}	total power dissipation	T _{mb} = 25 °C; <u>Fig. 2</u>	-	32	W

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Symbol	Parameter	Conditions		Min	Max	Unit
T _{stg}	storage temperature			-55	175	°C
T _j	junction temperature			-55	175	°C
Source-drain	diode FET1 and FET2		1	1	1	
I _S	source current	T _{mb} = 25 °C		-	15.4	Α
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$		-	71	Α
Avalanche Ruggedness FET1 and FET2						
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	I_D = 15.4 A; $V_{sup} \le 60 \text{ V}$; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; Fig. 3	[1][2]	-	11.6	mJ

- 1] Refer to application note AN10273 for further information
- [2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C

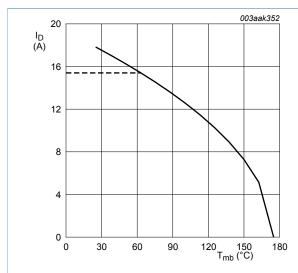


Fig. 1. Continuous drain current as a function of mounting base temperature

 $V_{GS} \ge 10 V$

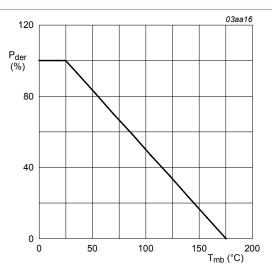


Fig. 2. Normalized total power dissipation as a function of mounting base temperature

$$P_{der} = \frac{P_{tot}}{P_{tot(25^{\circ}C)}} \times 100 \%$$

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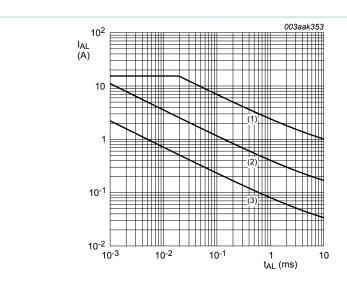
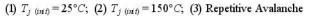


Fig. 3. Avalanche rating; avalanche current as a function of avalanche time



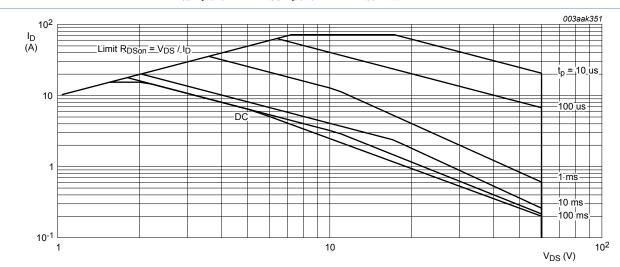


Fig. 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

 $T_{mb} = 25^{\circ}C$; I_{DM} is a single pulse

9. Thermal characteristics

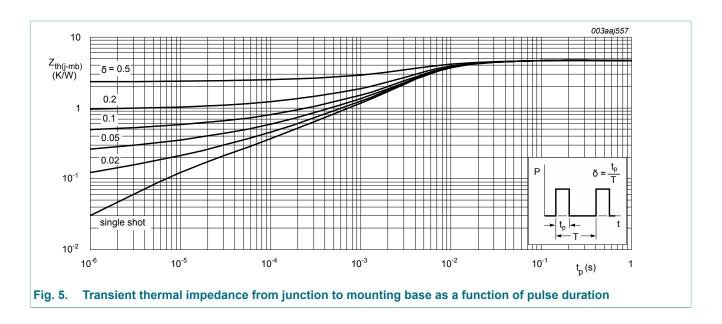
Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 5	-	-	4.68	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	Minimum footprint; mounted on a printed circuit board	-	95	-	K/W

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10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics FET1 and FET2					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \mu A; V_{GS} = 0 V; T_j = -55 °C$	54	-	-	V
		$I_D = 250 \mu A; V_{GS} = 0 V; T_j = 25 ^{\circ}C$	60	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ Fig. 9; Fig. 10	2.4	3	4	V
		I _D = 1 mA; V _{DS} = V _{GS} ; T _j = 175 °C; Fig. 9; Fig. 10	1	-	-	V
	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ Fig. 9; Fig. 10	-	-	4.5	V	
I _{DSS} drain leakage current	drain leakage current	V _{DS} = 60 V; V _{GS} = 0 V; T _j = 25 °C	-	0.02	1	μA
	V _{DS} = 60 V; V _{GS} = 0 V; T _j = 175 °C	-	-	500	μΑ	
I _{GSS}	gate leakage current	V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state	$V_{GS} = 10 \text{ V}; I_D = 5 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 11$	-	35	45	mΩ
	resistance	V _{GS} = 10 V; I _D = 5 A; T _j = 175 °C; Fig. 12; Fig. 11	-	78	101	mΩ
Dynamic ch	naracteristics FET1 and FE	T2				
Q _{G(tot)}	total gate charge	I _D = 5 A; V _{DS} = 48 V; V _{GS} = 10 V;	-	9.2	-	nC
Q_{GS}	gate-source charge	T _j = 25 °C; <u>Fig. 13</u> ; <u>Fig. 14</u>	-	2	-	nC
Q _{GD}	gate-drain charge		-	3.5	-	nC

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Parameter	Conditions	Min	Тур	Max	Unit
gate-source plateau voltage	I _D = 5 A; V _{DS} = 48 V; T _j = 25 °C; Fig. 13; Fig. 14	-	5	-	V
input capacitance	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz;	-	401	535	pF
output capacitance	T _j = 25 °C; <u>Fig. 15</u>	-	73	87	pF
reverse transfer capacitance		-	53	72	pF
turn-on delay time	$V_{DS} = 48 \text{ V}; R_L = 5 \Omega; V_{GS} = 10 \text{ V};$	-	4.3	-	ns
rise time	$R_{G(ext)} = 5 \Omega$; $T_j = 25 °C$; $I_D = 5 A$	-	5.1	-	ns
turn-off delay time		-	8.4	-	ns
fall time		-	5.4	-	ns
diode FET1 and FET2					
source-drain voltage	$I_S = 5 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 ^{\circ}\text{C}; Fig. 16$	-	0.83	1.2	V
reverse recovery time	$I_S = 5 \text{ A}; dI_S/dt = -100 \text{ A/}\mu\text{s}; V_{GS} = 0 \text{ V};$	-	17.6	-	ns
recovered charge	$V_{DS} = 30 \text{ V}; T_j = 25 \text{ °C}$	-	12.3	-	nC
	gate-source plateau voltage input capacitance output capacitance reverse transfer capacitance turn-on delay time rise time turn-off delay time fall time diode FET1 and FET2 source-drain voltage reverse recovery time	gate-source plateau voltage $I_D = 5 \text{ A}; V_{DS} = 48 \text{ V}; T_j = 25 \text{ °C};$ Fig. 13; Fig. 14 input capacitance output capacitance reverse transfer capacitance turn-on delay time turn-off delay time fall time $I_D = 5 \text{ A}; V_{DS} = 48 \text{ V}; T_j = 25 \text{ °C};$ Fig. 13; Fig. 14 $V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ Fig. 15}$ $V_{DS} = 48 \text{ V}; R_L = 5 \Omega; V_{GS} = 10 \text{ V};$ $R_{G(ext)} = 5 \Omega; T_j = 25 \text{ °C}; I_D = 5 \text{ A}$ diode FET1 and FET2 source-drain voltage $I_S = 5 \text{ A}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}; \text{ Fig. 16}$ reverse recovery time $I_S = 5 \text{ A}; \text{ dI}_S/\text{dt} = -100 \text{ A/µs}; V_{GS} = 0 \text{ V};$ $V_{CS} = 30 \text{ V}; T_S = 25 \text{ °C};$	gate-source plateau voltage $I_D = 5 \text{ A}; V_{DS} = 48 \text{ V}; T_j = 25 \text{ °C};$ - reverse transfer capacitance $I_D = 5 \text{ A}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz};$ - coutput capacitance $I_J = 25 \text{ °C}; Fig. 15$ - reverse transfer capacitance $I_J = 25 \text{ °C}; Fig. 15$ - reverse time $I_J = 25 \text{ °C}; I_J = 25$	gate-source plateau voltage $I_D = 5 \text{ A}$; $V_{DS} = 48 \text{ V}$; $T_j = 25 \text{ °C}$; - 5 input capacitance $V_{GS} = 0 \text{ V}$; $V_{DS} = 25 \text{ V}$; $f = 1 \text{ MHz}$; - 401 output capacitance $T_j = 25 \text{ °C}$; Fig. 15 - 73 reverse transfer capacitance - 53 turn-on delay time $V_{DS} = 48 \text{ V}$; $R_L = 5 \Omega$; $V_{GS} = 10 \text{ V}$; - 4.3 rise time $R_{G(ext)} = 5 \Omega$; $R_{J} = 25 \text{ °C}$; $R_{D} = 5 \text{ A}$ - 5.1 turn-off delay time - 8.4 fall time - 5.4 diode FET1 and FET2 - 0.83 reverse recovery time $R_{J} = 5 \text{ A}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} = 25 \text{ °C}$; $R_{J} = 0 \text{ V}$; $R_{J} =$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

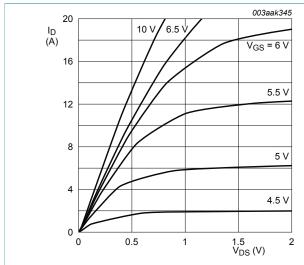


Fig. 6. Output characteristics; drain current as a function of drain-source voltage; typical values



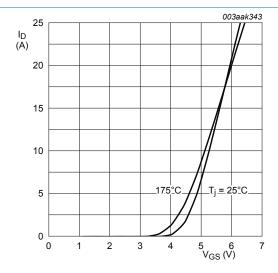


Fig. 7. Transfer characteristics; drain current as a function of gate-source voltage; typical values

$$V_{DS} = 10V$$

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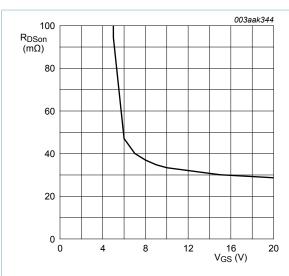


Fig. 8. Drain-source on-state resistance as a function of gate-source voltage; typical values

$$T_j = 25^{\circ}C; I_D = 5A$$

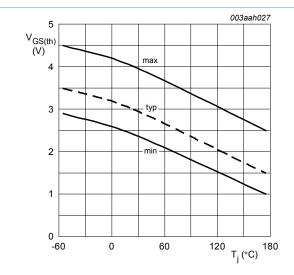


Fig. 10. Gate-source threshold voltage as a function of junction temperature

$$I_D = 1 \text{ mA}; \ V_{DS} = V_{GS}$$

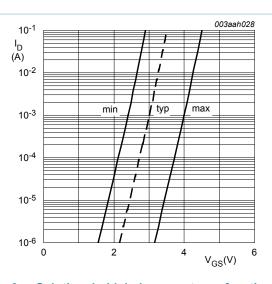


Fig. 9. Sub-threshold drain current as a function of gate-source voltage

$$T_j = 25^{\circ}C; \ V_{DS} = 5V$$

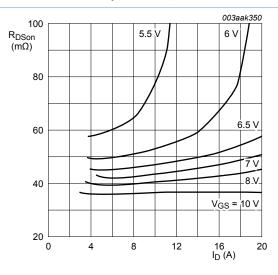


Fig. 11. Drain-source on-state resistance as a function of drain current; typical values

$$T_j = 25^{\circ}C$$

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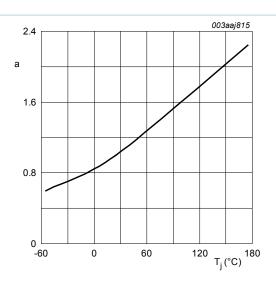


Fig. 12. Normalized drain-source on-state resistance factor as a function of junction temperature

$$a = \frac{R_{DSon}}{R_{DSon (25^{\circ}C)}}$$

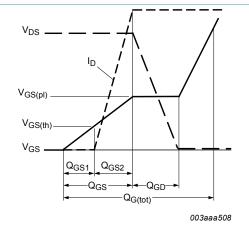


Fig. 14. Gate charge waveform definitions

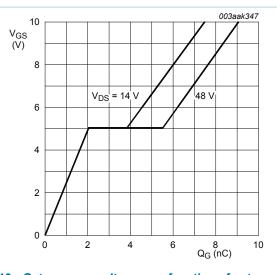


Fig. 13. Gate-source voltage as a function of gate charge; typical values

$$T_j = 25^{\circ}C; I_D = 5A$$

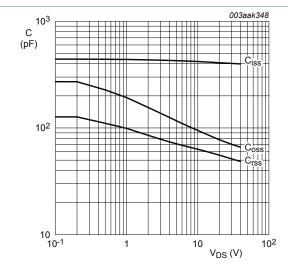


Fig. 15. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

$$V_{GS} = \mathbf{0}V; f = \mathbf{1}MHz$$

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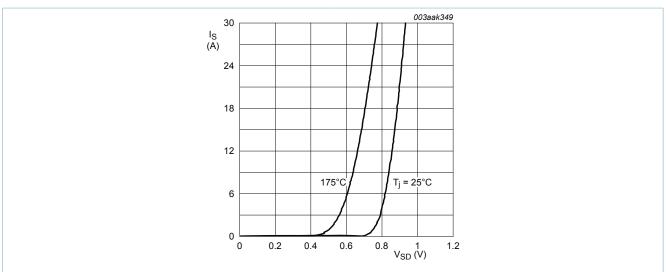


Fig. 16. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values

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11. Package outline

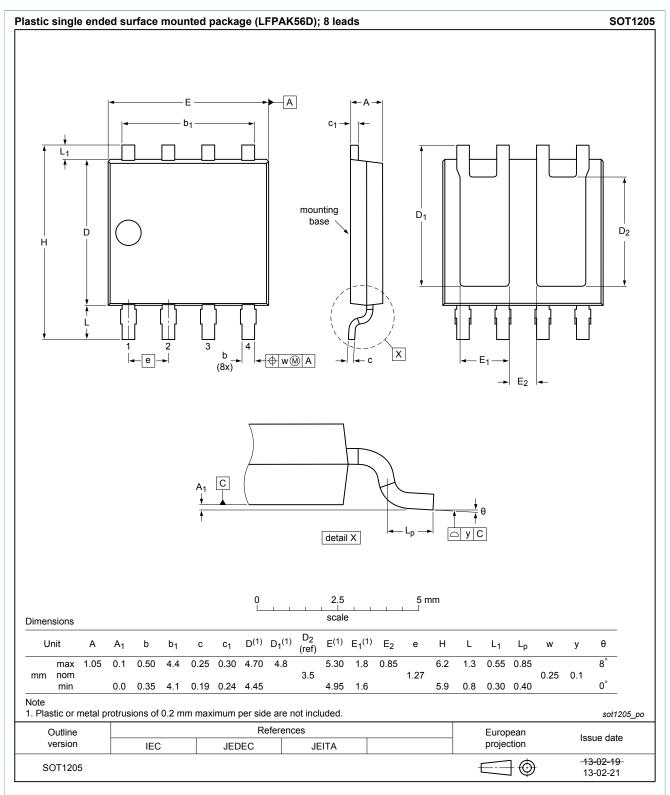


Fig. 17. Package outline LFPAK56D (SOT1205)

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Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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Date of release: 10 December 2013

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